

Please replace the second full paragraph on page 2 with the following:

A3 --An object of the present invention is to provide a molding material for use with carbon dioxide refrigerant, which can be used as suitable molding materials for sealing materials, etc. in carbon dioxide refrigerant-contacting apparatuses.- -

Please replace the third full paragraph on page 2 with the following:

A4 - -The object of the present invention can be attained by a molding material for use with carbon dioxide refrigerant, which comprises chlorinated polyethylene having a chlorine content of 25-47% by weight. A blend of chlorinated polyethylene with vinyl chloride-based resin can be also used. furthermore, it is particularly effective for prevention of blister generation to add a specific silane coupling agent thereto.- -

Please replace the first full paragraph on page 11 with the following:

A5 - -The present molding materials for use with carbon dioxide refrigerant with the foregoing properties can be used as suitable materials for sealing materials such as packings, gaskets, O-rings, etc. in carbon dioxide refrigerant-contacting apparatuses such as air compressors, refrigerators, supercritical CO₂ extraction(chromatography) apparatuses, etc. using carbon dioxide as a refrigerant, and also as suitable materials for sealing materials for refrigerator oil (polyalkylene glycol, etc.) applicable to the carbon dioxide refrigerant.- -

IN THE CLAIMS

Please amend claims 1-6 as follows:

- Sub B1
- A6
1. (Amended) A molding material for use with carbon dioxide refrigerant, which comprises chlorinated polyethylene having a chlorine content of 25-47% by weight.
 2. (Amended) A molding material for use with carbon dioxide refrigerant according to Claim 1, wherein the chlorinated polyethylene is used as a blend with vinyl chloride-based resin.
 3. (Amended) A molding material for use with carbon dioxide refrigerant according to Claim 1, wherein an inorganic filler is further contained.
 4. (Amended) A molding material for use with carbon dioxide refrigerant according to Claim 1, wherein a vinylic, epoxy or methacryloxy silane coupling agent is further contained.